Preferred Device

Switching Diode

Features

- SOD-123 Surface Mount Package
- High Breakdown Voltage
- Fast Speed Switching Time
- Pb-Free Packages are Available



ON Semiconductor®

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	100	Vdc
Peak Forward Current	IF	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	500	mAdc
Non-repetitive Peak Forward Surge Current Pulse Width =1 second Pulse Width =1 micro second	I _{FSM}	1.0 2.0	A A

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board (Note 1) T _A = 25°C Derate above 25°C	P _D	425 3.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	290	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

1. FR-5 = 1.0oz Cu, 1.0in^z pad



SOD-123 CASE 425 PLASTIC

MARKING DIAGRAM



5D = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

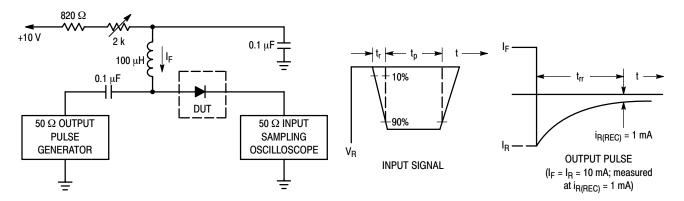
Device	Package	Shipping [†]
MMSD914T1	SOD-123	3000 / Tape & Reel
MMSD914T1G	SOD-123 (Pb-Free)	3000 / Tape & Reel
MMSD914T3	SOD-123	10,000 / Tape & Reel
MMSD914T3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	•	•		
Reverse Breakdown Voltage (I _{BR} = 100 μAdc)	V _(BR)	100	_	Vdc
Reverse Voltage Leakage Current $(V_R = 20 \text{ Vdc})$ $(V_R = 75 \text{ Vdc})$	I _R	_ _	25 5.0	nAdc μAdc
Forward Voltage (I _F = 10 mAdc)	V _F	_	1000	mVdc
Diode Capacitance (V _R = 0 Vdc, f = 1.0 MHz)	C _D	_	4.0	pF
Reverse Recovery Time (I _F = I _R = 10 mAdc) (Figure 1)	t _{rr}	_	4.0	ns

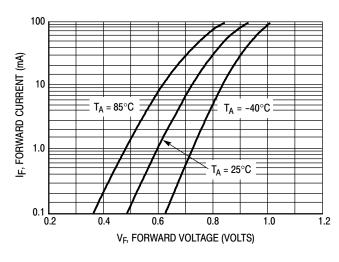


Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA.

2. Input pulse is adjusted so $I_{\mbox{\scriptsize R(peak)}}$ is equal to 10 mA.

3. $t_p \gg t_{rr}$

Figure 1. Recovery Time Equivalent Test Circuit



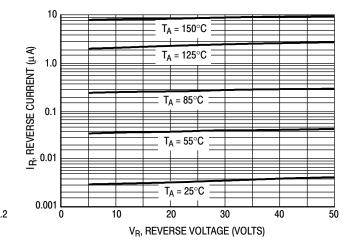


Figure 2. Forward Voltage

Figure 3. Leakage Current

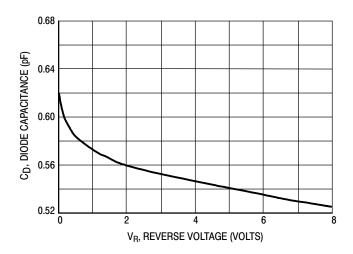
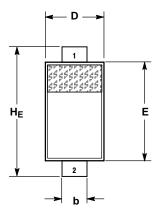
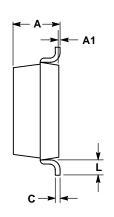


Figure 4. Capacitance

PACKAGE DIMENSIONS

SOD-123 CASE 425-04 ISSUE E

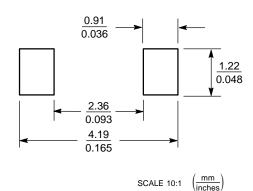




- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	M	ULIMETE	METERS INCHES			
- 1	MILLIMETERS					
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
С			0.15			0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
Е	2.54	2.69	2.84	0.100	0.106	0.112
HE	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25			0.010		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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